



UTMOST SPICE Modeling Software

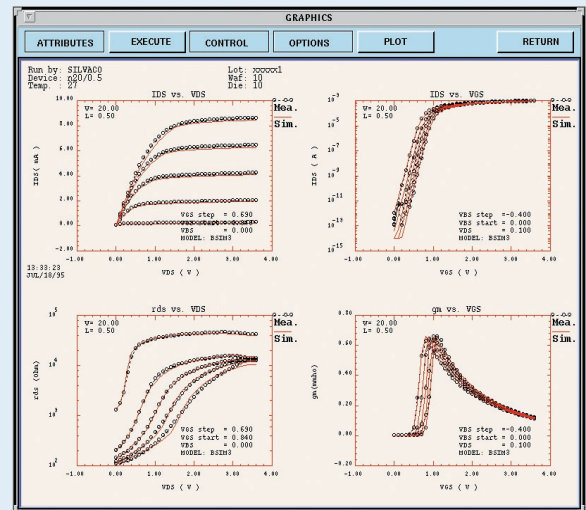
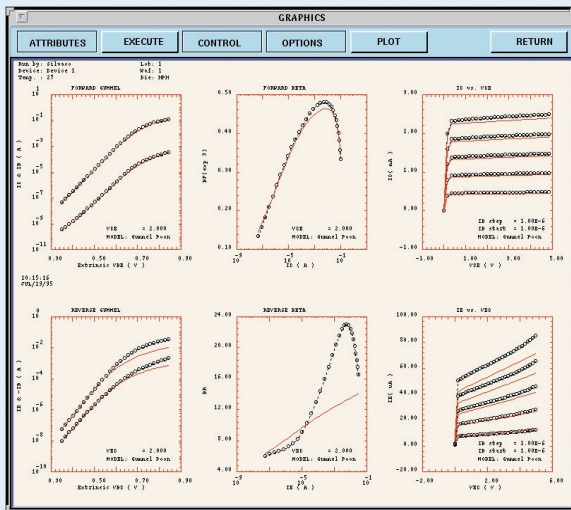


UTMOST™ SPICE Modeling Software generates the most accurate, linear, and continuous SPICE models for analog, mixed-signal, and nanometer digital applications. Leading IDMs, foundries, and fabless companies use UTMOST for the highest quality SPICE models from data acquisition, to parameter extraction, to model verification.

- Produces the most accurate, linear, and continuous SPICE models for analog and mixed-signal applications
- Offers the widest selection of pre-calibrated SPICE models from industry and universities for MOSFET, BJT, Diode, JFET, GaAs, SOI, TFT, and HBT
- Supports the widest selection of measurement equipment and probes from all vendors
- Fully interactive, semi-automatic or batch-mode operation with real-time model tuning with unique rubber-banding algorithm to achieve continuous models for rapid run-time SPICE convergence
- Integrated with TCAD and statistics package for smooth development of pre-silicon models
- Supports all leading SPICE simulators with DC, AC, transient, and capacitance test routines
- SPICE modeling services available using latest measurement equipment with 18 years experience

Test and Analysis Environment

- Flexible measurement and analysis environment for device characterization and model generation
- Supports widest selection of instrument drivers, prober drivers, device models, operating platforms, and commercial circuit simulators
- Splits device characterization or modeling problems into separate measurement and analysis tasks
- Stores measured results in measurement log files for future analysis (search, averaging) so that valuable probe time is minimized
- Uses common data sets for extraction of parameters from different models
- Supports single test or step-and-repeat operation
- Extracts parameters with comprehensive library of built-in extraction algorithms, flexible user-defined local optimization strategies, more interactive global optimization procedures, or a combination of all three
- Store extracted parameters in multiple formats, including SPICE library format that can be read back into UTMOST as an initial estimate during future parameter extractions



UTMOST acquires measured or TCAD simulated data, extracts parameters, and delivers accurate, linear, and continuous SPICE models

NAME	VALUE	NAME	VALUE
LEVEL	7	VTH0	0.6555758
VTH0	0.6555758	K1	0.60933584
K1	0.60933584	K2	8.139483E-3
K2	8.139483E-3		

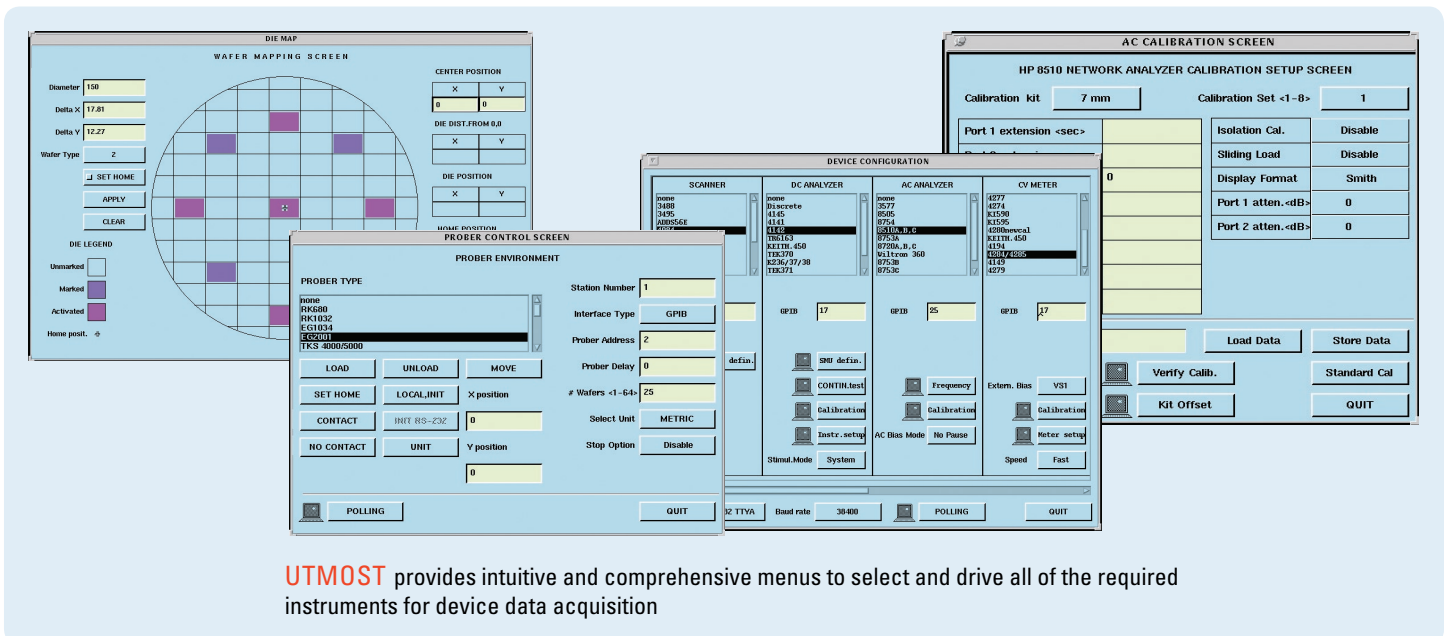
NAME	VALUE	NAME	VALUE
LEVEL	7	VTH0	0.6555758
VTH0	0.6555758	K1	0.60933584
K1	0.60933584	K2	8.139483E-3
K2	8.139483E-3		

Opt	Name	Optimized	Fit Initial	User Initial	Minimum	Maximum
1	LEVEL	7	7	7	1	60
2	VTH0	0.6555758	0.6555758	-0.8	-1.5	1.5
3	K1	0.60933584	0.60933584	0.5	0	2
4	K2	8.139483E-3	8.139483E-3	-0.05	-0.2	0.2
5	K3	-0.702197	-0.702197	80	-20	100
6	K30	0	0	-20	-20	20
7	W0	-2.062026E-6	-2.062026E-6	2E-6	-1E-5	1E-5
8	NLX	1.241616E-7	1.241616E-7	1E-7	1E-9	1E-5
9	DV10	1.2576893	1.2576893	1.5	0	10
10	DV11	0.9055427	0.9055427	0.5	0	2

UTMOST addresses the practical needs of device characterization and modeling engineers with a flexible, productive workflow

Data Acquisition

- Drives most commonly used DC analyzers, AC analyzers, capacitance meters, switching matrix controllers, pulse generators, and oscilloscopes
- Controls most commercial automatic and semi-automatic probers
- Drives many temperature ovens and hot chucks
- Fully interactive, semi-automatic, or batch-mode operation
- Step-and-repeat operation, including wafer cassette control
- Configures elaborate computer controlled test systems
- Comprehensive selection of DC, AC, transient, and capacitance test routines for MOSFET, BJT, Diode, JFET, GaAs, SOI, TFT, and HBT modules
- Performs capacitance, transient, or s-parameter measurements on packaged devices, on a wafer or in wafer, stepping mode
- Interfaces to process and device simulators and to the SPAYN™ Statistical Parameter Analysis tool
- Supports the widest variety of models and circuit simulators



UTMOST provides intuitive and comprehensive menus to select and drive all of the required instruments for device data acquisition

UTMOST supports the widest selection of instruments

DC Analyzers

HP4145
 HP4141
 HP4142
 HP4155/56
 Keithley 236
 Keithley 237
 Keithley 238
 Keithley S450
 Tektronics 370/370A
 Tektronics 371/371A

AC Analyzers

HP8510A,B,C
 HP8720A,B,C,D,E
 HP8753A,B,C,D,E
 HP3577
 HP8505
 HP8754
 HP8751
 Wiltcon 360
 HP8722D

Scanners

HP4084
 HP4085
 HP4086
 HP3488
 HP3495
 HP3852A
 Keithley 705
 Keithley 706
 Keithley 707
 Keithley 7002
 RACAL 1251

Capacitance Meters

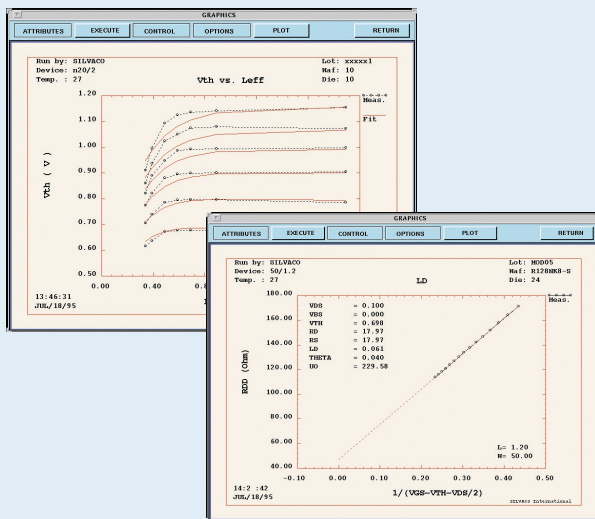
HP4284
 HP4285
 HP4262
 HP4271
 HP4192
 HP4275, HP4276, HP4277
 HP4274
 HP4280
 HP4194
 HP4279
 Keithley 590
 Keithley 595

Probers

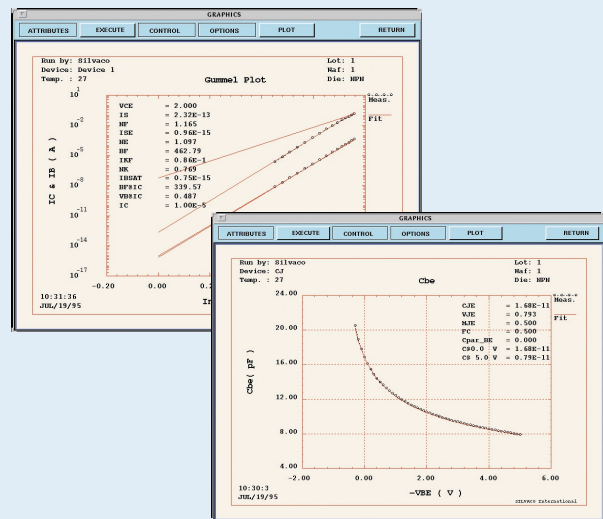
Electroglas 1034
 RK 680
 RK 681
 Cascade Summit
 Alessi 5500
 TKS 4000
 TKS 6000
 Tokyo
 Electron
 Electroglas 2001
 RK 1032
 Alessi 4500
 Karl Suss (PE100/PA200 II)
 TKS 3000
 TKS 5000
 Wentworth MP-1100

Parameter Extraction

- Includes comprehensive set of DC extraction routines for process-monitor and device model parameters
- Flexible local optimization procedures for any supported model as substitute or supplement to built-in routines
- Supports bipolar routines to extract resistance, breakdown, saturation, temperature, leakage, forward and reverse gain, early voltage, knee current, bipolar junction capacitance, and basic Gummel-Poon parameters from DC measured characteristics
- Provides extraction routines for cut off frequency, forward and reverse transit time, base resistance, and excess phase parameters are implemented for s-parameter measurements
- Extracts DC MOSFET parameters including length reduction, width reduction, threshold voltage, low-field mobility, body effect, velocity saturation, resistance, breakdown, and subthreshold slope parameters
- Supports the extraction of overlap and junction capacitances from capacitance measurements



UTMOST extracts MOSFET parameters, including BSIM4



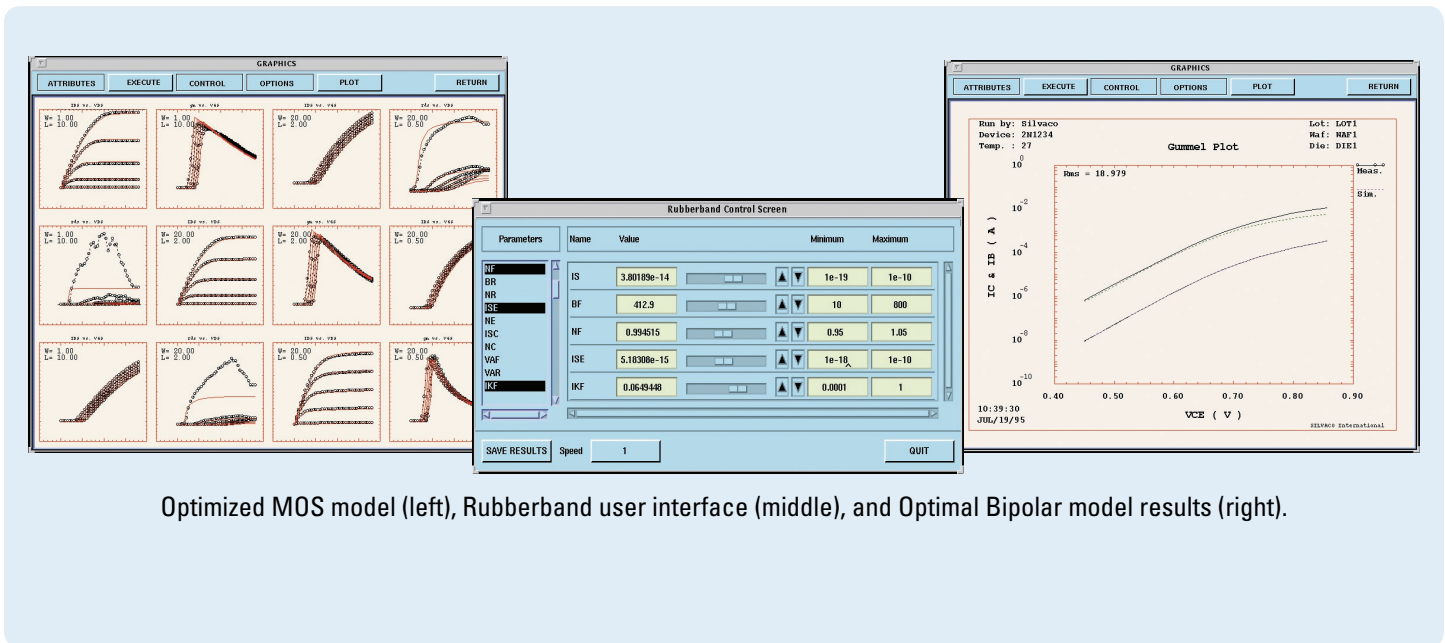
UTMOST extracts parameters for Bipolar (above), BJT, Diode, JFET, GaAs, SOI, TFT, HBT, and passive devices for RF

Advanced Parameter Extraction

- SOI module permits characterization of all transistor properties, including 4/5 terminals device, bipolar parasitic effects, and Body or BackGate currents
- Measured s-parameters can be converted to h, z, and y-parameters
- Supports standard, one step and two step, de-embedding procedures for determining MOSFET s-parameters
- Includes special extraction algorithms for the extraction of BSIM1, BSIM2, BSIM3, and MOS9 parameters, for single or multiple geometries
- Available universal multi-target / multi-geometry measurement routine for SOI and MOS technology

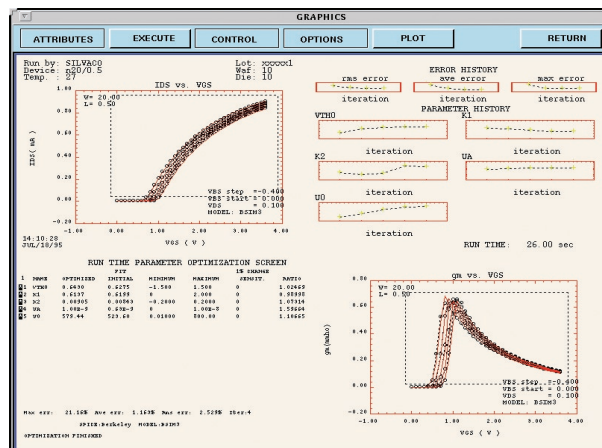
Parameter Optimization

- Offers both local and global parameter optimization options
- Optimize multiple device geometries simultaneously (up to 36 devices) and mix device currents and conductances as optimization targets
- Rubberband interactive parameter extraction defines initial parameter estimates enabling modeling engines to observe the effects of parameter variations on device characteristics
- Supports single or multi-geometry optimization with graphical updating of simulated characteristics and supports multi-step optimization all in real-time
- Offers flexible local optimization facility and optimization boundary boxes
- Supports graphical parameter sensitivity and error history information



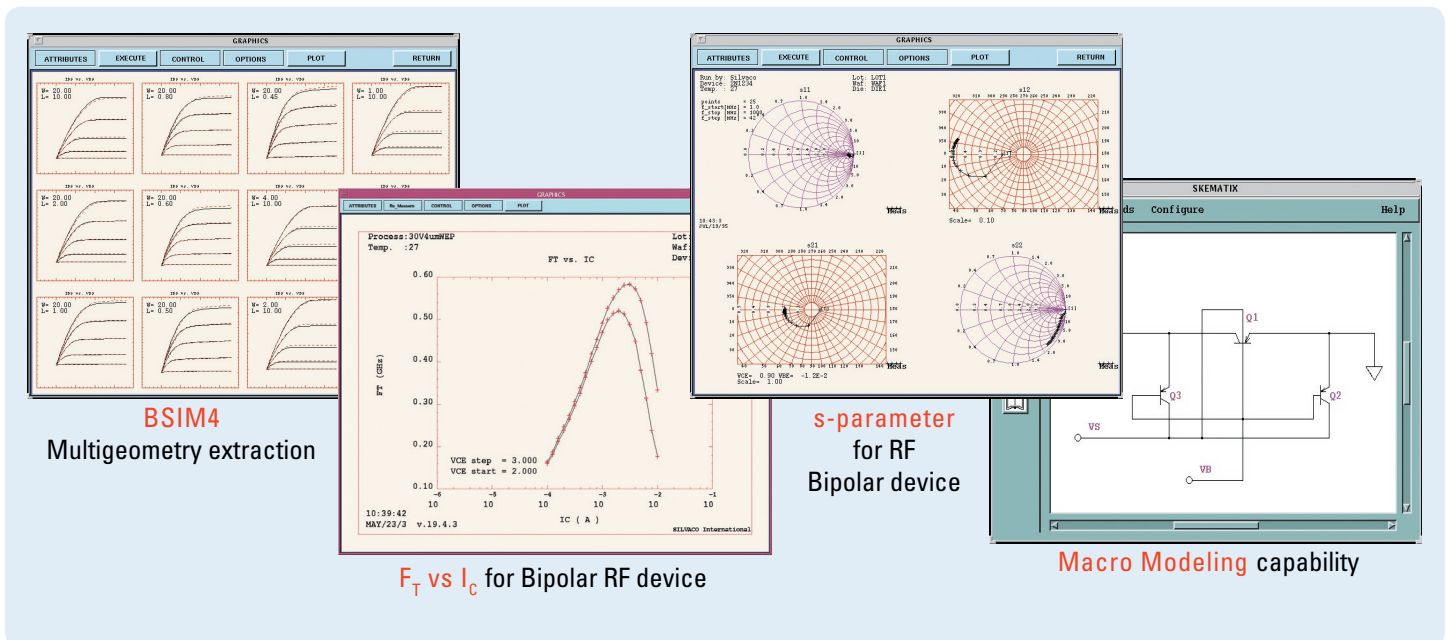
Optimized MOS model (left), Rubberband user interface (middle), and Optimal Bipolar model results (right).

UTMOST supports both Levenberg-Marquardt methodology, which computes both first and second derivative for quick conversion, and the simpler Downhill Simplex methodology.



Model Generation

- Supports widest selection of commercially available device models
- Offers model definition choice between External SPICE, SmartLib™, and Internal Models
- External SPICE mode accesses models native to target SPICE simulator
- SmartLib mode accesses SmartSpice™ supported models or those models dynamically linked to SmartSpice for Rubberband mode operation
- Internal Models mode accesses models hard-coded into UTMOST
- Supports the conversion of model parameter sets from one model to another
- Macro modeling and parameter extraction is available for devices which cannot be adequately modeled by any existing device models
- User-defined models linked dynamically
- Support for SmartSpice interpreter models
- Supports large number of commercial device models, some of which are listed below
- Fast simulation using SmartLib Model and Fast internal solver



Model Features

MOSFET models

Berkeley Level 1
Berkeley Level 2
Berkeley Level 3
BSIM1
BSIM2
BSIM3
Philips Level 9
EKV
MASTAR
BSIM4
Philips Level 11
User models

Bipolar models

Gummel-Poon
Quasi RC
IGBT
QBBJT MEXTRAM
HBT
HICUM
MEXTRAM504
User models

SOI model

Honeywell
FLORIDA FD
FLORIDA NFD
BSIM3SOI FD
BSIM3SOI DD
BSIM3SOI PD
STAG SOI
CEA/LETI
User models

MESFET model

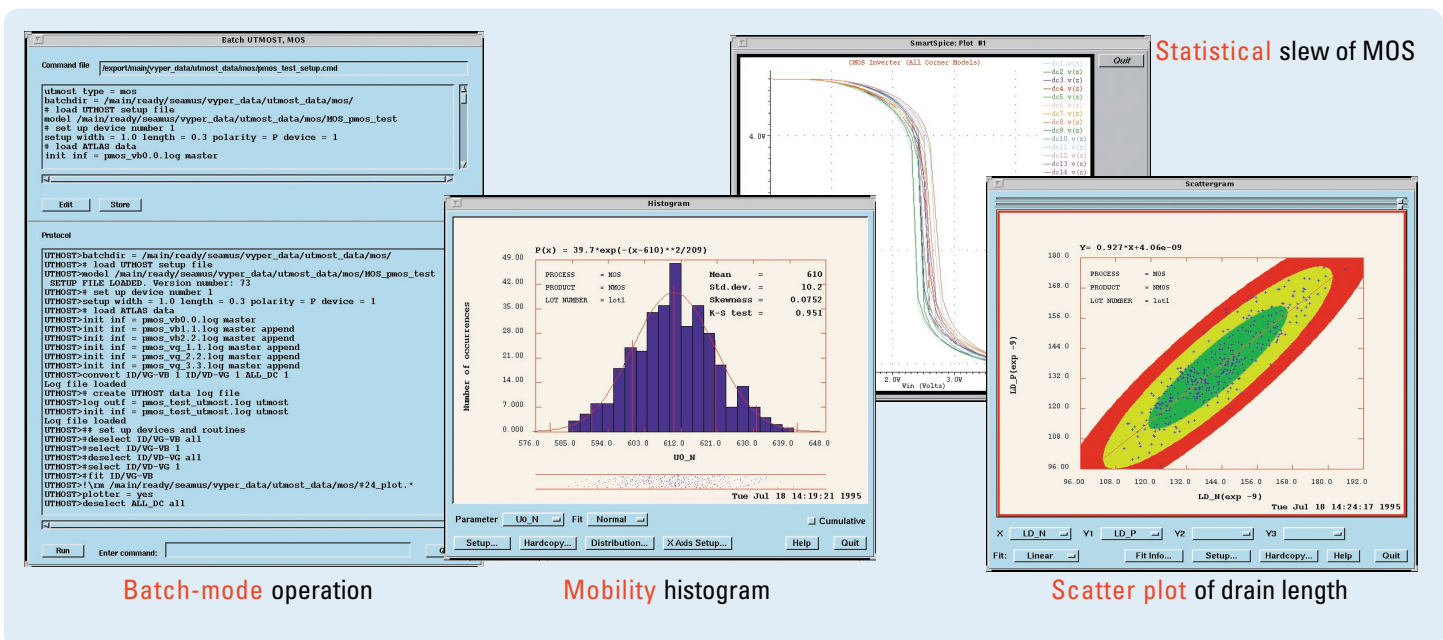
JFET
Statz
Curtice 1
Curtice 2
User models

TFT models

Amorphous TFT
Polysilicon TFT
RPI a-Si
RPI p-Si

UTMOST Operation

- Operates in manual, semi-automatic, automatic, and batch mode operation
- Includes technology modules for MOS, Bipolar, Diode, JFET, GaAs, SOI, TFT, and HBT
- Automatically converts TCAD device characteristics from TCAD process and device simulations
- Performs detailed parameter extractions on TCAD data in batch mode to develop nominal and worst-case models for a process under development
- Stores model parameters and device characteristics in SPAYN format for statistical parametric analysis and worst-case model definitions



Specifications

Equipment

Agilent/HP
Keithley
Tektronics
Wiltron

Probers

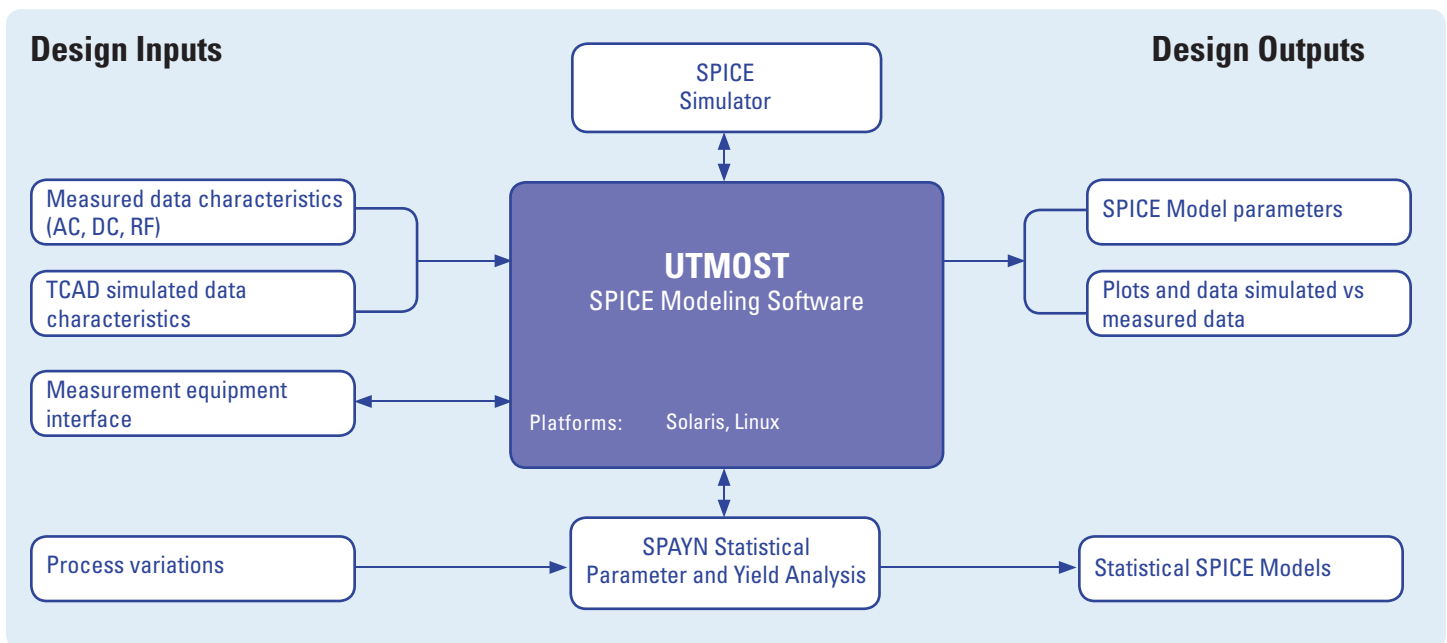
Electrogas
Rucker-Koll
Cascade-Summit
TKS
TEL
Karl Suss
Wentworh
Alessi

Circuit Simulators

SmartSpice™
HSpice™
PSpice™
Spectre™
ELDO™

Spice Modeling Services

- Leader in supplying accurate SPICE models from wafers or packaged parts
- Aggressive in providing rapid turnaround
- Specializing in BSIM3 and BSIM4 models for analog/mixed-signals
- Extraction of DC, AC (s-parameters), capacitance, temperature, noise, and SPICE parameters
- Temperature range from -55 degrees C to + 150 degrees C
- All commercially available SPICE models supported
- Model validation in accordance with Fabless Semiconductor Association (FSA), Compact Modeling Council, and IEEE test procedure #P1485 recommendations
- Deliver worst case and corner model generation



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